









# **CEP140N10**

#### 100V Δ 6.1mΩ Δ 137A Δ Si MOSFET

SILICON Si MOSFET ▲ THT type
N-channel enhancement mode
UL94V-0 rated flame retardant epoxy
TO220-3L package

Super high dense cell density for extremely low R<sub>DS(ON)</sub> **High power and current handling capability** 

# **MAXIMUM RATINGS**

| Parameter (T <sub>C</sub> = 25°C, unless otherwise noted) |                                   | Characteristics |
|---|-----------------------------------|-----------------|
| Drain-Source Voltage                                      | V <sub>DS</sub>                   | 100V            |
| Gate-Source Voltage                                       | V <sub>GS</sub>                   | ±20V            |
| Continuous Drain Current at T <sub>C</sub> = 25°C         | <b>I</b> D                        | 137A            |
| Continuous Drain Current at T <sub>C</sub> = 100°C        | <b>I</b> D                        | 87A             |
| Pulsed Drain Current Note 1                               | I <sub>DM</sub>                   | 548A            |
| Maximum Power Dissipation at T <sub>C</sub> = 25°C        | P <sub>D</sub>                    | 208W            |
| Power Dissipation Derating above 25°C                     | $\Delta P_D$                      | 1.7W/°C         |
| Single Pulsed Avalanche Energy Note 4                     | E <sub>AS</sub>                   | 800mJ           |
| Single Pulsed Avalanche Current Note 4                    | I <sub>AS</sub>                   | 40A             |
| Operating and Storage Temperature Range                   | T <sub>J</sub> , T <sub>STG</sub> | -55°C to +150°C |

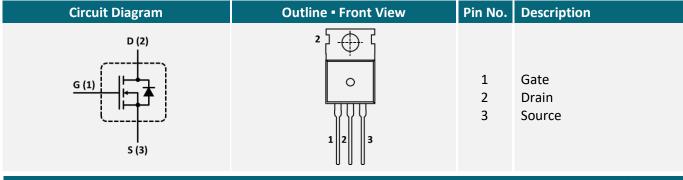
#### THERMAL CHARACTERISTICS

| Parameter                                      | Symbol             | Limit    |
|--|--------------------|----------|
| Thermal Resistance, Junction-to-Case           | R <sub>TH_JC</sub> | 0.6°C/W  |
| Thermal Resistance, Junction-to-Ambient Note 2 | R <sub>TH JA</sub> | 62.5°C/W |

#### **APPLICATIONS**

| Battery Management Systems | E-Bike | Industrial<br>Control | Power<br>Inverter | UPS |
|----------------------------|--------|-----------------------|-------------------|-----|
| +4-                        | 50     |                       |                   |     |

# **PIN DESCRIPTION**





# **ELECTRICAL CHARACTERISTICS** ▲ T<sub>C</sub> = 25°C, unless otherwise noted

| Item   | Condition  | Symbol                    | Min. | Тур. | Max. | Unit |
|--|--|---------------------------|------|------|------|------|
| Off Characteristics                                    |  |                           |      |      |      |      |
| Drain-Source Breakdown Voltage                         | $V_{GS} = 0V$ , $I_D = 250\mu A$   | $BV_DSS$                  | 100  |      |      | V    |
| Zero Gate Voltage Drain Current                        | $V_{DS} = 100V, V_{GS} = 0V$   | I <sub>DSS</sub>          |      |      | 1    | μΑ   |
| Gate Body Leakage Current, Forward                     | $V_{GS} = 20V, V_{DS} = 0V$  | $I_{GSSF}$                |      |      | 100  | nA   |
| Gate Body Leakage Current, Reverse                     | $V_{GS} = -20V, V_{DS} = 0V$   | I <sub>GSSR</sub>         |      |      | -100 | nA   |
| On Characteristics Note 3                              |  |                           |      |      |      |      |
| Gate Threshold Voltage                                 | $V_{GS} = V_{DS}$ , $I_D = 250 \mu A$                                      | $V_{GS(th)}$              | 2    |      | 4    | V    |
| Static Drain-Source On-Resistance                      | $V_{GS} = 10V, I_D = 35A$  | R <sub>DS(ON)</sub>       |      | 6.1  | 7.5  | mΩ   |
| Dynamic Characteristics Note 3                         |  |                           |      |      |      |      |
| Input Capacitance                                      | $V_{DS} = 25V$ , $V_{GS} = 0V$ , $f = 800kHz$                              | C <sub>ISS</sub>          |      | 6650 |      | pF   |
| Output Capacitance                                     | $V_{DS} = 25V$ , $V_{GS} = 0V$ , $f = 800kHz$                              | Coss                      |      | 605  |      | pF   |
| Reverse Transfer Capacitance                           | $V_{DS} = 25V$ , $V_{GS} = 0V$ , $f = 800kHz$                              | $C_{RSS}$                 |      | 495  |      | pF   |
| Switching Characteristics Note 3                       |  |                           |      |      |      |      |
| Turn-On Delay Time                                     | $V_{DD}$ = 50V, $V_{GS}$ = 10V, $I_{D}$ = 70A, $R_{G(ext)}$ = 2.5 $\Omega$ | t <sub>D(ON)</sub>        |      | 44   |      | ns   |
| Turn-On Rise Time                                      | $V_{DD}$ = 50V, $V_{GS}$ = 10V, $I_D$ = 70A, $R_{G(ext)}$ = $2.5\Omega$    | t <sub>R</sub>            |      | 23   |      | ns   |
| Turn-Off Delay Time                                    | $V_{DD}$ = 50V, $V_{GS}$ = 10V, $I_D$ = 70A, $R_{G(ext)}$ = 2.5 $\Omega$   | t <sub>D(OFF)</sub>       |      | 98   |      | ns   |
| Turn-Off Fall Time                                     | $V_{DD}$ = 50V, $V_{GS}$ = 10V, $I_{D}$ = 70A, $R_{G(ext)}$ = $2.5\Omega$  | $t_{\scriptscriptstyleF}$ |      | 27   |      | ns   |
| Total Gate Charge                                      | $V_{DD} = 80V$ , $V_{GS} = 10V$ , $I_D = 70A$                              | $Q_{G}$                   |      | 231  |      | nC   |
| Gate Source Charge                                     | $V_{DD} = 80V$ , $V_{GS} = 10V$ , $I_D = 70A$                              | $Q_{GS}$                  |      | 63   |      | nC   |
| Gate Drain Charge                                      | $V_{DD} = 80V$ , $V_{GS} = 10V$ , $I_D = 70A$                              | $Q_{GD}$                  |      | 70   |      | nC   |
| Drain-Source Diode Characteristics and Maximum Ratings |  |                           |      |      |      |      |
| Drain-Source Diode<br>Forward Current                  |  | Is                        |      |      | 137  | Α    |
| Drain-Source Diode<br>Forward Voltage Note 2           | V <sub>GS</sub> = 0V, I <sub>S</sub> = 35A                                 | $V_{\text{SD}}$           |      |      | 1.5  | V    |

#### Notes

- 1: Repetitive Rating: Pulse width limited by maximum junction temperature
- 2: Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 3: Guaranteed by design, not subject to production testing.
- 4: L = 1mH,  $I_{AS}$  = 40A,  $V_{DD}$  = 25V,  $R_G$  = 25Ω, Starting  $T_J$  = 25°C



lb, Drain Current (A)

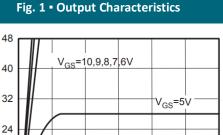
16

8

0

0

#### REFERENCE DATA A TYPICAL DEVICE PERFORMANCE



VDS, Drain-to-Source Voltage (V)

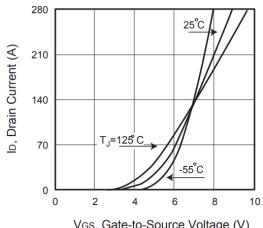
4

5

6

3

Fig. 2 • Transfer Characteristics



Vgs, Gate-to-Source Voltage (V)

Fig. 3 • Capacitance

2

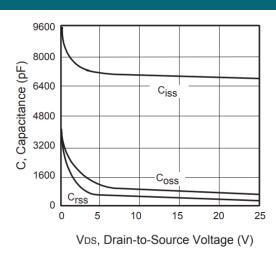


Fig. 4 • On-Resistance Variation with Temperature

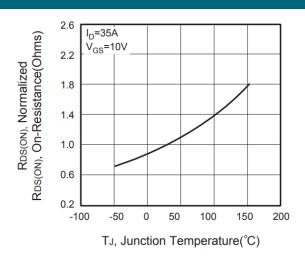


Fig. 5 • Gate Threshold Variation with Temperature

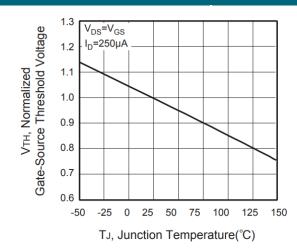
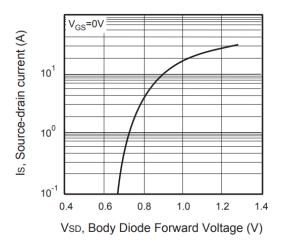


Fig. 6 • Body Diode Forward Voltage Variation with Source Current



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#### REFERENCE DATA A TYPICAL DEVICE PERFORMANCE

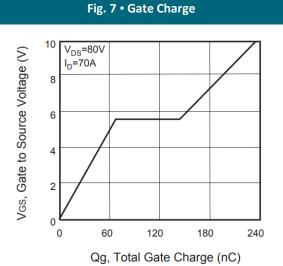


Fig. 8 • Maximum Safe Operating Area

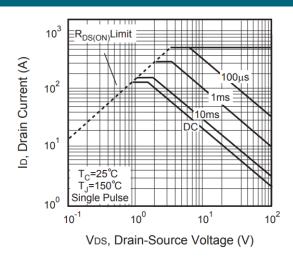
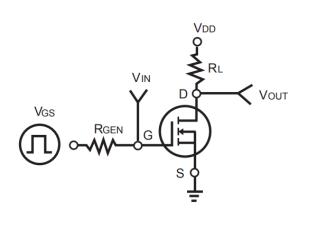


Fig. 9 • Switching Test Circuit

Fig. 10 • Switching Waveforms



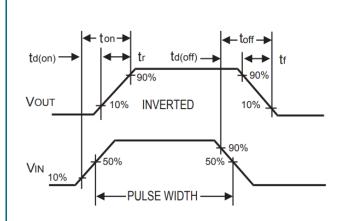
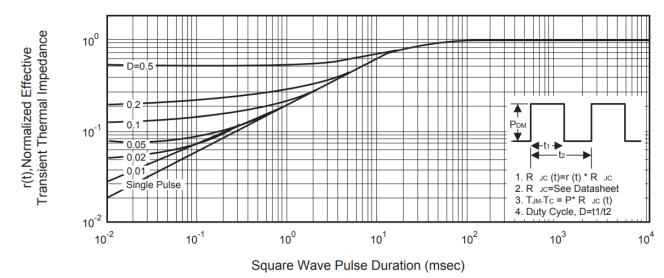


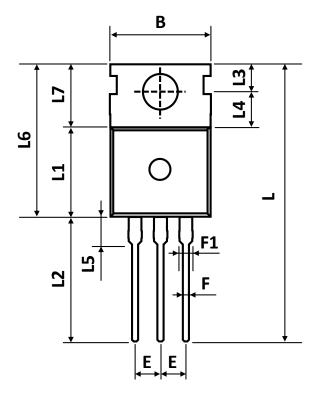
Fig. 11 • Switching Test Circuit

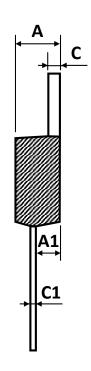


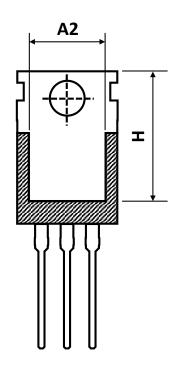
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# **PACKAGE OUTLINE**







| Sym | Millimeters<br>(Min.) | Millimeters (Typ.) | Millimeters (Max.) |
|-----|-----------------------|--------------------|--------------------|
| Α   | 4.43                  | 4.53               | 4.63               |
| A1  | 2.30                  | 2.40               | 2.50               |
| A2  | 7.70                  | 7.90               | 8.10               |
| В   | 9.80                  | 10.00              | 10.20              |
| С   | 1.25                  | 1.30               | 1.40               |
| C1  | 0.45                  | 0.50               | 0.60               |
| D   | 3.45                  | 3.60               | 3.70               |
| E   | 2.45                  | 2.54               | 2.60               |
| F   | 0.70                  | 0.80               | 0.95               |
| F1  | 1.15                  | 1.33               | 1.50               |
| L   | 26.80                 | 28.80              | 30.80              |
| L1  | 9.20                  | 9.30               | 9.40               |
| L2  | 12.80                 | 13.10              | 13.40              |
| L3  | 2.70                  | 2.80               | 2.90               |
| L4  | 3.50                  | 3.70               | 3.80               |
| L5  | 2.60                  | 2.90               | 3.20               |
| L6  | 15.40                 | 15.80              | 16.20              |
| L7  | 6.20                  | 6.50               | 6.80               |
| Н   | 12.95                 | 13.25              | 13.55              |

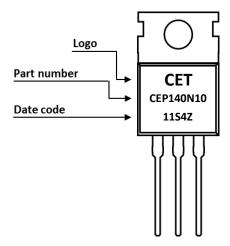
# **ORDERING INFORMATION**

| Part Number | Package   | Packing | Tube Qty. | Inner Box Qty. | Outer Box Qty. |
|-------------|-----------|---------|-----------|----------------|----------------|
| CEP140N10   | TO-220-3L | Tube    | 50pcs     | 1,000pcs       | 4,000pcs       |

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#### **PART MARKING**



#### **DATE CODE**

Example: 11S4Z



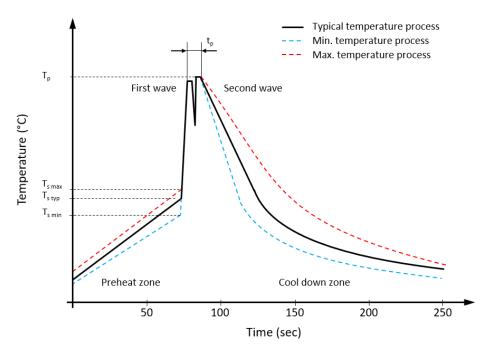


Coding list for "Day"





# RECOMMENDED WAVE SOLDERING PROFILE A THT PACKAGE



# Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

| Profile Features                                 |                    | Value ▲ Sn-Pb Assembly                     | Value ▲ Pb-free Assembly                   |
|--|--------------------|--|--|
| Preheat temperature min.                         | $T_{smin}$         | 100 °C                                     | 100 °C                                     |
| Preheat temperature typical                      | T <sub>s typ</sub> | 120 °C                                     | 120 °C                                     |
| Preheat temperature max.                         | $T_{smax}$         | 130 °C                                     | 130 °C                                     |
| Preheat time $t_s$ from $T_{smin}$ to $T_{smax}$ | ts                 | 70 seconds                                 | 70 seconds                                 |
| Peak temperature                                 | $T_p$              | 235 °C to 260 °C                           | 245 °C to 260 °C                           |
| Time of actual peak temperature                  | t <sub>p</sub>     | Max. 10 seconds<br>Max. 5 second each wave | Max. 10 seconds<br>Max. 5 second each wave |
| Ramp-down date min.                              |                    | ~ 2 °C/second                              | ~ 2 °C/second                              |
| Ramp-down rate typical                           |                    | ~ 3.5 °C/second                            | ~ 3.5 °C/second                            |
| Ramp-down rate max.                              |                    | ~ 5 °C/second                              | ~ 5 °C/second                              |
| Time 25°C to 25°C                                |                    | 4 minutes                                  | 4 minutes                                  |



#### **REVISION TABLE**

| Revision | Date       | Status          | Notes               |
|----------|------------|-----------------|---------------------|
| 001      | 30/09/2022 | Initial release | Initial publication |
|          |            |                 |                     |
|          |            |                 |                     |
|          |            |                 |                     |
|          |            |                 |                     |
|          |            |                 |                     |

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